



ASSEMBLY at uniboard PCB 2773 B/C:

- 1) C6, C15, C28 OPEN
- 2) L2, L3 OPEN
- 3) L4, R12, R14, R15 SHORT
- 4) D2, Q3, R4, R13 OPEN
- 5) C13, C14, C27, R11 will not meet pattern
- 7) ref des 100 mounted externally
- 7) R6 replaced by ORing diode 100

- NOTES:
- 1) R9 for test purposes only
 - 2) L1 WE 1210 series for max. effcy
 - 3) L1 WE 1050 series 744 771 4 100 for min. size

Revision History	
Revision	Notes
A	* First release
B	* adjusted loop & RC snubber

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Number: PMP10026 | Rev: B
 SVN Rev: Version control disabled
 Drawn By:
 Engineer: B.Geck

Designed for: Public Release | Mod. Date: 9/22/2015
 Project Title: holdup boost converter 6.5V @ 2Amps
 Sheet Title:
 Assembly Variant: [No Variations] | Sheet: 1 of 1
 File: PMP10026RevB_SchDoc | Size: A4
 Contact: <http://www.ti.com/support>



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